

HGTG12N60D1D

12A, 600V N-Channel IGBT with Anti-Parallel Ultrafast Diode

April 1995

Features

- 12A, 600V
- Latch Free Operation
- Typical Fall Time <500ns
- Low Conduction Loss
- With Anti-Parallel Diode
- t_{RR} < 60ns

Description

The IGBT is a MOS gated high voltage switching device combining the best features of MOSFETs and bipolar transistors. The device has the high input impedance of a MOSFET and the low on-state conduction loss of a bipolar transistor. The much lower on-state voltage drop varies only moderately between +25°C and +150°C. The diode used in parallel with the IGBT is an ultrafast (t_{RR} < 60ns) with soft recovery characteristic.

The IGBTs are ideal for many high voltage switching applications operating at frequencies where low conduction losses are essential, such as: AC and DC motor controls, power supplies and drivers for solenoids, relays and contactors.

PACKAGING AVAILABILITY

PART NUMBER	PACKAGE	BRAND					
HGTG12N60D1D	TO-220AB	G12N60D1D					
NOTE: When ordering use the entire part number							

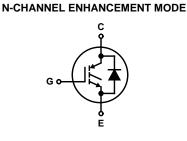
NOTE: When ordering, use the entire part number

EMITTER COLLECTOR GATE COLLECTOR (BOTTOM SIDE METAL)

JEDEC STYLE TO-247

Terminal Diagram

Package



Absolute Maximum Ratings	$T_{C} = +25^{\circ}C$, Unless Otherwise Specified
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						HGTG12N60D1D	UNITS
Collector-Emitter \	/oltage				BV _{CES}	600	V
Collector-Gate Vo	ltage R _{GE} = 1MΩ				BV _{CGR}	600	V
Collector Current	Continuous at T _C	= +25°C			I _{C25}	21	А
	at T _C	= +90°C			I _{C90}	12	А
Collector Current I						48	А
Gate-Emitter Volta	ge Continuous				. V _{GES}	±20	V
Switching Safe Op	erating Area at T	J = +150°C			.SSOA	30A at 0.8 BV _{CES}	-
Diode Forward Cu	rrent at T _C = +25	°C			I _{F25}	21	А
	at T _C = +90	°C			I _{F90}	12	А
Power Dissipation	Total at $T_C = +2$	5°C			P _D	75	W
Power Dissipation	Derating $T_C > +2$	25°C				0.6	W/ºC
Operating and Sto	rage Junction Te	mperature Range		T	J, T _{STG}	-55 to +150	°C
Maximum Lead Te	emperature for So	ldering			T ₁	260	°C
(0.125 inches fro		-			-		
NOTE:							
1. Repetitive Rat	ting: Pulse width	limited by maxim	um junction temp	erature.			
	0000004710						
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4,364,073	4,417,385	4,430,792	4,443,931	4,466,176	4,516,143	4,532,534	4,567,641	
4,587,713	4,598,461	4,605,948	4,618,872	4,620,211	4,631,564	4,639,754	4,639,762	
4,641,162	4,644,637	4,682,195	4,684,413	4,694,313	4,717,679	4,743,952	4,783,690	
4,794,432	4,801,986	4,803,533	4,809,045	4,809,047	4,810,665	4,823,176	4,837,606	
4,860,080	4,883,767	4,888,627	4,890,143	4,901,127	4,904,609	4,933,740	4,963,951	
4,969,027								

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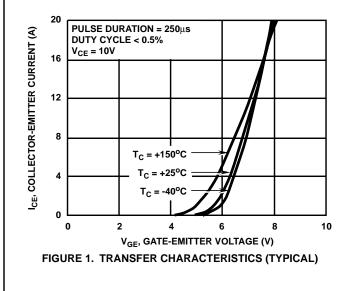
					LIMITS	MITS				
PARAMETERS	SYMBOL	TEST CONDITIONS		MIN	TYP	MAX	UNITS			
Collector-Emitter Breakdown Voltage	BV _{CES}	$I_{C} = 280 \mu A, V_{GE} = 0 V$		600	-	-	V			
Collector-Emitter Leakage Voltage	I _{CES}	$V_{CE} = BV_{CES}$	T _C = +25 ^o C	-	-	280	μA			
		$V_{CE} = 0.8 \text{ BV}_{CES}$	T _C = +125°C	-	-	5.0	mA			
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	$I_{\rm C} = I_{\rm C90}, V_{\rm GE} = 15 {\rm V}$	T _C = +25°C	-	1.9	2.5	V			
			T _C = +125°C	-	2.1	2.7	V			
Gate-Emitter Threshold Voltage	V _{GE(TH)}	$I_C = 250 \mu A, V_{CE} = V_G$	_E , T _C = +25°C	3.0	4.5	6.0	V			
Gate-Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 20V$		-	-	±500	nA			
Gate-Emitter Plateau Voltage	V _{GEP}	$I_{C} = I_{C90}, V_{CE} = 0.5 \text{ BV}_{CES}$		-	7.2	-	V			
On-State Gate Charge	Q _{G(ON)}	$I_{\rm C} = I_{\rm C90},$	V _{GE} = 15V	-	45	60	nC			
		$V_{CE} = 0.5 BV_{CES}$	V _{GE} = 20V	-	70	90	nC			
Current Turn-On Delay Time	t _{D(ON)I}	L = 500μ H, I _C = I _{C90} , R _G = 25V, V _{GE} = 15V, T _J = +150°C, V _{CE} = 0.8 BV _{CES}		-	100	-	ns			
Current Rise Time	t _{RI}			-	150	-	ns			
Current Turn-Off	t _{D(OFF)} I			-	430	600	ns			
Current Fall Time	t _{Fl}	1		-	430	600	ns			
Turn-Off Energy (Note 1)	W _{OFF}	1		-	1.8	-	mJ			
Thermal Resistance IGBT	$R_{ extsf{ heta}JC}$			-	-	1.67	°C/W			
Thermal Resistance Diode	$R_{ extsf{ heta}JC}$			-	-	1.5	°C/W			
Diode Forward Voltage	V _{EC}	I _{EC} = 12A		-	-	1.50	V			
Diode Reverse Recovery Time	t _{RR}	I _{EC} = 12A, dI _{EC} /dt = 100A/μs		-	-	60	ns			

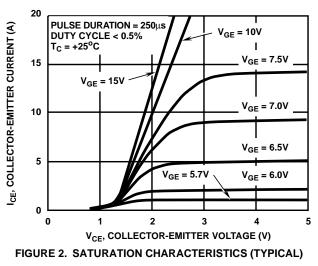
Electrical Specifications $T_{C} = +25^{\circ}C$, Unless Otherwise Specified

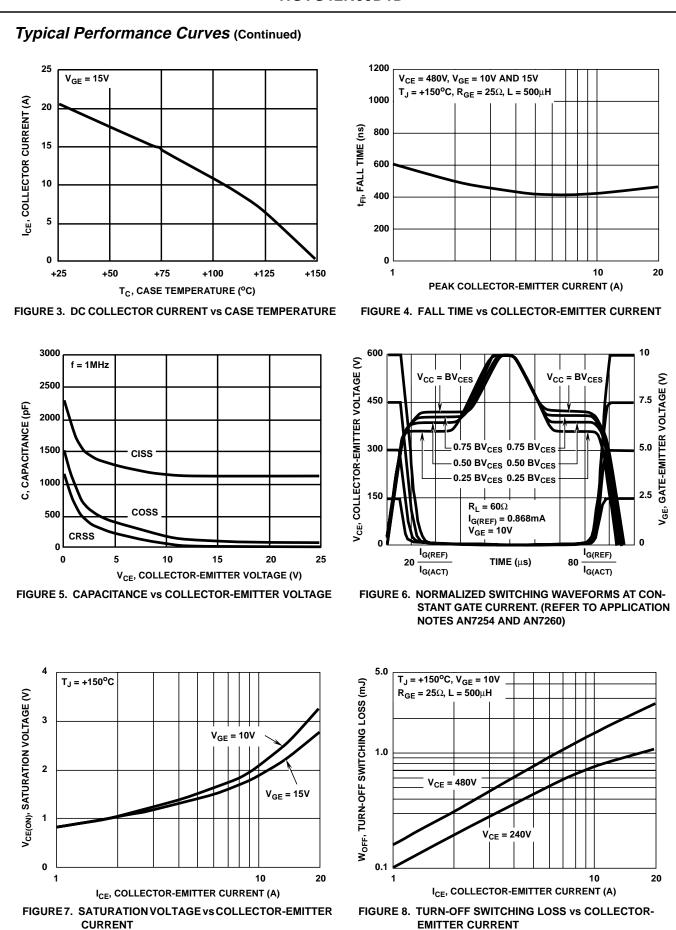
NOTE:

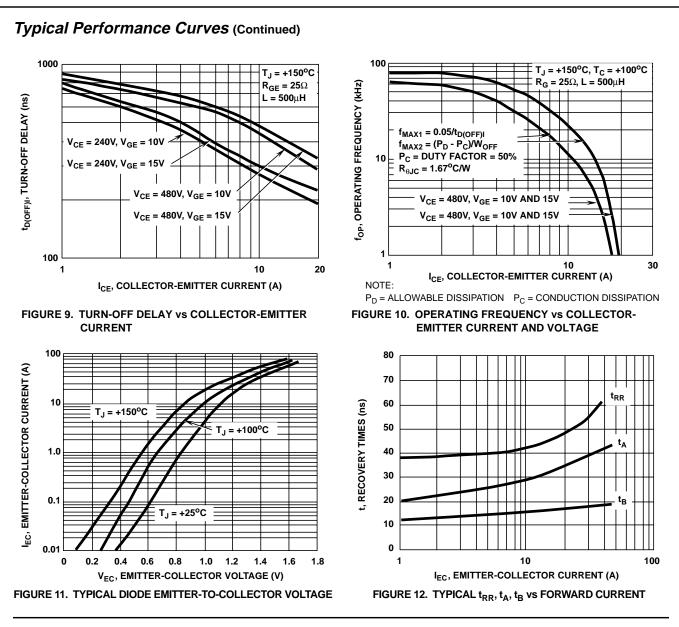
 Turn-off Energy Loss (W_{OFF}) is defined as the integral of the instantaneous power loss starting at the trailing edge of the input pulse and ending at the point where the collector current equals zero (I_{CE} = 0A). The HGTG12N60D1D was tested per JEDEC standard No. 24-1 Method for Measurement of Power Device Turn-off Switching Loss. This test method produces the true total Turn-off Energy Loss.

Typical Performance Curves









Operating Frequency Information

Operating frequency information for a typical device (Figure 10) is presented as a guide for estimating device performance for a specific application. Other typical frequency vs collector current (I_{CE}) plots are possible using the information shown for a typical unit in Figures 7, 8 and 9. The operating frequency plot (Figure 10) of a typical device shows f_{MAX1} or f_{MAX2} whichever is smaller at each point. The information is based on measurements of a typical device and is bounded by the maximum rated junction temperature.

 f_{MAX1} is defined by $f_{MAX1} = 0.05/t_{D(OFF)I}$, $t_{D(OFF)I}$ deadtime (the denominator) has been arbitrarily held to 10% of the onstate time for a 50% duty factor. Other definitions are possible, $t_{D(OFF)I}$ is defined as the time between the 90% point of the trailing edge of the input pulse and the point where the collector current falls to 90% of its maximum value. Device turn-off delay can establish an additional

frequency limiting condition for an application other than T_{JMAX} . $t_{D(OFF)I}$ is important when controlling output ripple under a lightly loaded condition.

 f_{MAX2} is defined by $f_{MAX2} = (P_D - P_C)/W_{OFF}$. The allowable dissipation (P_D) is defined by $P_D = (T_{JMAX} - T_C)/R_{\theta JC}$. The sum of device switching and conduction losses must not exceed P_D . A 50% duty factor was used (Figure 10) so that the conduction losses (P_C) can be approximated by $P_C = (V_{CE} \times I_{CE})/2$. W_{OFF} is defined as the sum of the instantaneous power loss starting at the trailing edge of the input pulse and ending at the point where the collector current equals zero ($I_{CE} - 0A$).

The switching power loss (Figure 10) is defined as $f_{MAX1} \times W_{OFF}$. Turn on switching losses are not included because they can be greatly influenced by external circuit conditions and components.

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